

powersafe™

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Product Fact Sheet

Industrial M.2 SATA SSD

X-75m2 2280 P Series
SATA Gen3 – 6.0 Gbit/s, 3D TLC

Commercial and Industrial
Temperature Grade

Date: November 18, 2021
Revision: 1.00



Product Fact Sheet

X-75m2 2280 P Series



Product Summary

- **Capacities:** 240 GBytes, 480 GBytes, 960 GBytes, 1920 GBytes
- **Form Factor:** PCI Express™ M.2 (2280) (80 mm x 22 mm x 3.58 mm)
- **Compliance:** SATA Gen3 – 6 Gbit/s (Gen2 – 3 Gbit/s and Gen1 – 1.5 Gbit/s backward compatible)
- **Command Sets:** Supports ATA/ATAPI-8 and ACS-2
- **Performance:**
 - Read Performance: Sequential Read up to 560 MBytes/s, Random Read 4K up to 77,700 IOPS
 - Write Performance: Sequential Write up to 500 MBytes/s, Random Write 4K up to 71,200 IOPS
- **Operating Temperature Range¹:**
 - Commercial: 0 °C to 70 °C
 - Industrial: -40 °C to 85 °C
- **Storage Temperature Range:** -40 °C to 85 °C
- **Operating Voltage:** 3.3 V ± 5%
- **Power (Max):** Read (Active): 1.7 W; Write (Active): 2.3 W; Idle: 365 mW; Partial: 130 mW
- **Data Retention:** 10 Years @ Life Begin; 1 Year @ Life End
- **Endurance in TeraBytes Written (TBW) @ Max Capacity²:** Sequential WL ≥ 6,485; Client WL ≥ 730; Enterprise WL ≥ 1,200
- **Shock/Vibration:** 1,500 g / 50 g
- **LDPC ECC** with up to 165 bit correction per 1 KByte page
- **NAND Flash Technology:** Triple-Level Cell (TLC) 3D NAND Flash
- **Mean Time Between Failure:** > 2,000,000 hours
- **Data Reliability:** < 1 non-recoverable error per 10¹⁶ bits read

Product Features

- Dynamic and Static Wear Leveling
- Active and Passive Data Care Management
- Lifetime Enhancements
 - Dynamic Bad Block Remapping
 - Write Amplification Reduction
- On-Board Power Fail Protection
- TRIM and NCQ Support
- ATA Security Feature Set Support
- DEVSLP Compatible
- In-Field Firmware Update
- Enterprise-Grade Self-Monitoring, Analysis, and Reporting Technology (S.M.A.R.T.)
- 30 μinch Gold-Plated Connector (IPC-6012B Class 2 Compliant)
- End-to-End (E2E) Data Protection
- powersafe™ Functionality
- AES256 Encryption (on request)
- TCG OPAL 2.0 Compliant (on request)
- Swissbit Life Time Monitoring (SBLTM) Tool and SDK for SBLTM (on request)

Why Swissbit?

Swissbit is focused on the design, development, manufacture, and support of leading edge memory and storage solutions for the worldwide OEM/ODM marketplace. As a global supplier, Swissbit recognizes and addresses the higher level of application requirements of today's industrial, Netcom, and automotive customers by providing best-in-class products and services, with uncompromised attention to driving overall value and quality.

¹ Adequate airflow is required to ensure the temperature, as reported in the S.M.A.R.T. data, does not exceed 110°C (industrial temperature drive) and 95°C (commercial temperature drive) respectively.

² According to JEDEC (JESD471), the time to write the full TBW is a minimum of 18 months. Higher average daily data volume reduces the specified TBW. The values listed are estimates and are subject to change without notice.